

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image













Similar to illustration

OMNIMATE Power BV / SV 7.62HP – the 28 kVA performance class

Tailor-made solutions for high performers

More power reserves for higher load bearing capacity: The OMNIMATE Power BV / SV 7.62HP is the middle-class of the power connector systems. It has a large clamping capacity, high overload resistance and the largest range of variants and accessories to choose from: the high performer of the HP range. HP means High Performance – this performance covers a great deal: the full rated current up to 50°C without derating, unlimited 600-V approval according to UL, and the additional finger safety for 400 V-TN systems (+ 3.0 mm) in compliance with the application directive IEC 61800-5-1.

General ordering data

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 7.62 mm, Number of poles: 2, 270°, Solder pin length (I): 2.6 mm, tinned, black, Box
Order No.	<u>2499330000</u>
Туре	SV-SMT 7.62HP/02/270G 2.6SN BK BX
GTIN (EAN)	4050118512427
Qty.	120 pc(s).
Product data	IEC: 1000 V / 41 A
	UL: 300 V / 40.5 A
Packaging	Вох

Creation date April 15, 2021 10:46:56 PM CEST



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Technical data

Dimensions and weights

Depth	28.3 mm	Depth (inches)	1.114 inch
Height of lowest version	11.4 mm	Net weight	4 g

System specifications

Product family	OMNIMATE Power - series BV/SV 7.62HP	Type of connection	Board connection	
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	7.62 mm	
Pitch in inches (P)	0.3 inch	Outgoing elbow	270°	
Number of poles	2	Number of solder pins per pole	2	
Solder pin length (I)	2.6 mm	Solder pin length tolerance	+0.1 / -0.3 mm	
Solder pin dimensions 0.8 x 1.0 mm		Solder eyelet hole diameter (D)	1.4 mm	
Solder eyelet hole diameter tolera	ance (D)+ 0,1 mm	L1 in mm	7.62 mm	
1 in inches 0.3 inch		Number of rows	1	
Pin series quantity	1	Touch-safe protection acc. to DIN VDE 57 106	safe to back of hand above the printed circuit board	
Touch-safe protection acc. to DIN	VDE	Volume resistance		
0470	0470 IP 20		2.00 mΩ	
Plugging cycles	25	Plugging force/pole, max.	12 N	
Pulling force/pole, max.	7 N			

Material data

Insulating material	PA GF HT3	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	
Comparative Tracking Index (CTI)	≥ 600	Insulation strength	≥ 10 ⁸ Ω
Moisture Level (MSL)	3	UL 94 flammability rating	V-0
Contact material	Copper alloy	Contact surface	tinned
Layer structure of solder connection	13 µm Ni / 46 µm Sn matt	Layer structure of plug contact	13 µm Ni / 46 µm Sn matt
Storage temperature, min.	-40 °C	Storage temperature, max.	70 °C
Operating temperature, min.	-50 °C	Operating temperature, max.	130 °C
Temperature range, installation, min.	-25 °C	Temperature range, installation, max.	130 °C

Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	41 A
Rated current, max. number of poles (Tu=20°C)	41 A	Rated current, min. number of poles (Tu=40°C)	41 A
Rated current, max. number of poles (Tu=40°C)	41 A	Rated voltage for surge voltage class / pollution degree II/2	1,000 V
Rated voltage for surge voltage class / pollution degree III/2	630 V	Rated voltage for surge voltage class / pollution degree III/3	630 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	6 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	6 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	6 kV	Short-time withstand current resistance	3 x 1s with 420 A



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Technical data

Institute (cURus)		Certificate No. (cURus)	
	C THE US	1	E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group C / UL 1059)	300 V
Rated voltage (Use group D / UL 1059)	300 V	Rated current (Use group B / UL 1059)	40.5 A
Rated current (Use group C / UL 1059)	40.5 A	Rated current (Use group D / UL 1059)	10 A
Clearance distance, min.	6.9 mm	Creepage distance, min.	9.6 mm
Reference to approval values	Specifications are maximum values, details - see approval certificate.		
Packing			
Packaging	Box	VPE length	338 mm
VPE width	130 mm	VPE height	33 mm
Classifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01
Important note			
IPC conformity	standards and norms and comp	eveloped, manufactured and delivered according ly with the assured properties in the data sheet i Class 2". Further claims on the products can be e	resp. fulfill decorative properti
Notes	Additional colours on request		•
	Rated current related to rated	cross-section & min. No. of poles.	
	. Dan dan in a mital		

- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

Approvals

Approvals UL File Number Search

Downloads

Engineering Data	<u>STEP</u>	
Brochure/Catalogue	Catalogues in PDF-format	



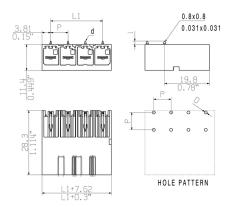
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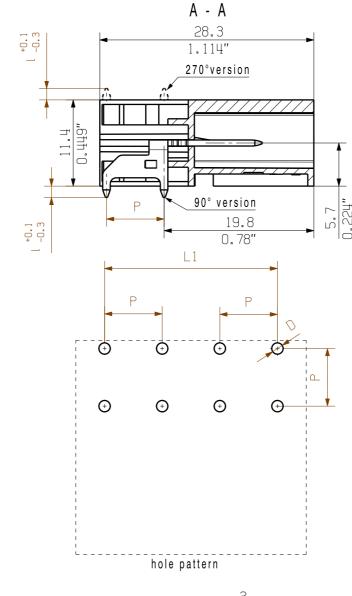
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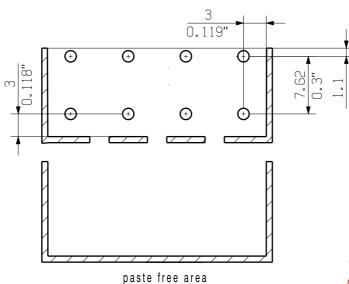
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Drawings

Dimensional drawing







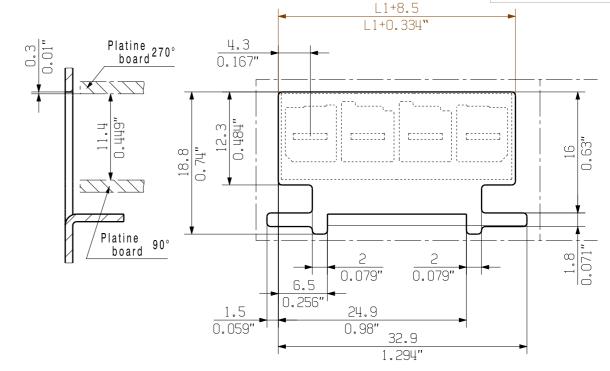
max. dimension

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components

The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application.
Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.



min.front plate cut out

P = Raster / pitch 7.62

 $D = \emptyset 1.4 + 0.1/-0.05$ d = 0.8x1.0

GENERAL TOLERANCE

Scale: 2:1

Drawings Assembly

	8	53.34	2.1
	7	45.72	1.8
	6	38.10	1.5
1.5	5	30.48	1.2
	4	22.86	0.9
2.6	3	15.24	0.6
3.5	2	7.62	0.3
[100,100]	no of	L1	L1

12

11

10

83.82 3.3 76.20 3.0

68.58 2.7

60.96 2.4

The English version is binding

	DIN ISO	. TOLEHANCE: 2768-m					[mm]		no po	of les	L1 [mm]	L1 [inch]
		EC00002212			Prim PLM	Part No.: 225880		Prim E	RP Part	No.:	249955	0000
	ROMS		Max. nos		147	: .I :: II			63450		4	
		First Issue Date	Modification		Weidmüller 🐔			Drawing no	_	of 17	Issue no.	
				Date	Name							
34				30.08.2019	19 Helis, Maria SV-SMT 7 62HD/I			SV-SMT 7.62HP/IT//90/270				
			Resnonsible		Döhrer Karl	1 01-0	, III I 1 1 V	6	11/11/3	0 2	V 1 1 1	

Size: A3 Approved 09.10.2019 Lang, Thomas

STISTLEISTE MALE HEADER

Product file: 7407 BLF 7.50HP

SV-SMT 7.62HP/04/90G





SV-SMT 7.62HP/04/270G



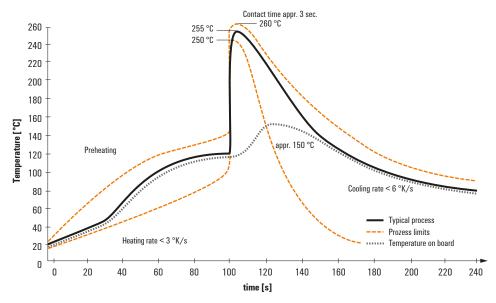
Recommended wave solderding profiles

Weidmüller Interface GmbH & Co. KG

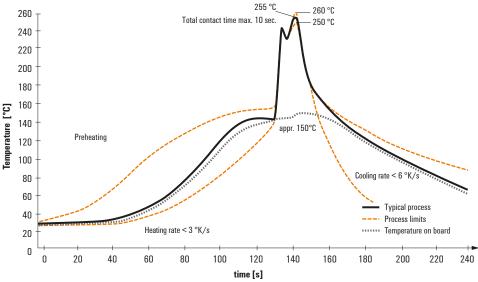
Klingenbergstraße 16 D-32758 Detmold Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

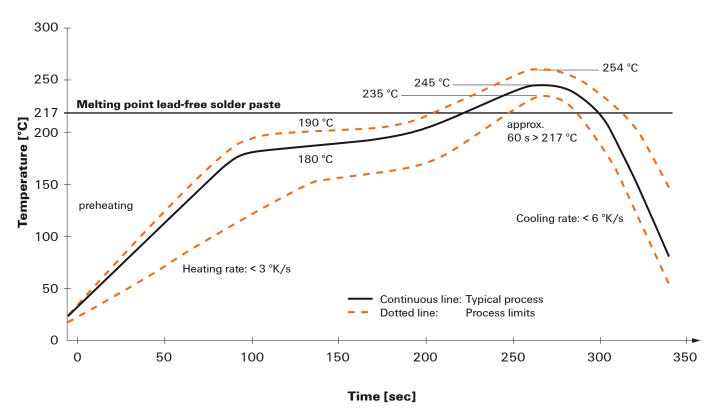


Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- · Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.